INTEGRATED CIRCUITS

DATA SHEET

74LV240

Octal buffer/line driver; inverting (3-State)

Product specification Supersedes data of 1997 Feb 19 IC24 Data Handbook





Octal buffer/line driver; inverting (3-State)

74LV240

FEATURES

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce) < 0.8 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C$
- Output capability: bus driver
- I_{CC} category: MSI

DESCRIPTION

The 74LV240 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT240.

The 74LV240 is an octal inverting buffer/line driver with 3-State outputs. The 3-State outputs are controlled by the output enable inputs 10E and 20E. A HIGH on nOE causes the outputs to assume a high impedance OFF-state. The 74LV240 is identical to the 74LV244 but has inverting outputs.

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}C$; $t_{r} = t_{f} \le 2.5 \text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay 1A _n to 1Y _n ; 2A _n to 2Y _n	$C_L = 15 \text{ pF};$ $V_{CC} = 3.3 \text{ V}$	9.0	ns
C _I	Input capacitance		3.5	pF
C _{PD}	Power dissipation capacitance per buffer	$V_{CC} = 3.3 \text{ V}$ $V_I = \text{GND to } V_{CC}^1$	30	pF

NOTE:

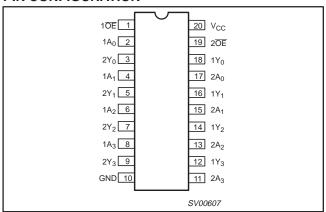
- 1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW) $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 - f_i = input frequency in MHz; C_L = output load capacitance in pF; f_0 = output frequency in MHz; V_{CC} = supply voltage in V;

 - $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of the outputs.}$

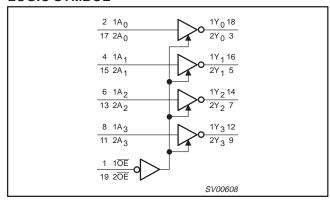
ORDERING INFORMATION

ONDERWING IN ORMANICA				
PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
20-Pin Plastic DIL	-40°C to +125°C	74LV240 N	74LV240 N	SOT146-1
20-Pin Plastic SO	-40°C to +125°C	74LV240 D	74LV240 D	SOT163-1
20-Pin Plastic SSOP Type II	-40°C to +125°C	74LV240 DB	74LV240 DB	SOT339-1
20-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV240 PW	74LV240PW DH	SOT360-1

PIN CONFIGURATION



LOGIC SYMBOL



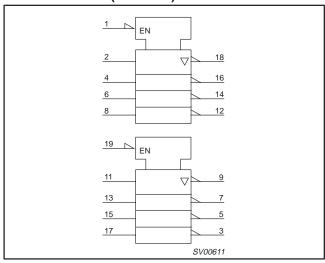
Octal buffer/line driver; inverting (3-State)

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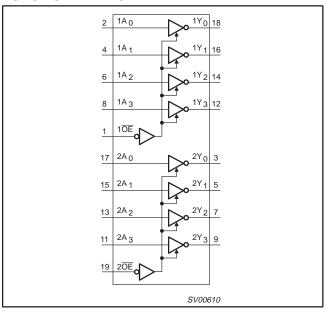
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION				
1	1 OE	Output enable input (active LOW)				
2, 4, 6, 8	1A ₀ to 1A ₃	Data inputs				
3, 5, 7, 9	2Y ₀ to 2Y ₃	Bus outputs				
10	GND	Ground (0 V)				
17, 15, 13, 11	2A ₀ to 2A ₃	Data inputs				
18, 16, 14, 12	1Y ₀ to 1Y ₃	Bus outputs				
19 2 OE		Output enable input (active LOW)				
20	V _{CC}	Positive supply voltage				

LOGIC SYMBOL (IEEE/IEC)



FUNCTIONAL DIAGRAM



FUNCTION TABLE

INP	OUTPUT	
nOE	nA _n	nY _n
L	L	Н
L	Н	L
Н	Х	Z

NOTES:

H = HIGH voltage level
L = LOW voltage level
X = don't care

X = Z = high impedance OFF-state

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V _{CC}	DC supply voltage	See Note 1	1.0	3.3	5.5	V
VI	Input voltage		0	ı	V _{CC}	V
Vo	Output voltage		0	ı	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 1.0V \text{ to } 2.0V \\ V_{CC} = 2.0V \text{ to } 2.7V \\ V_{CC} = 2.7V \text{ to } 3.6V \\ V_{CC} = 3.6V \text{ to } 5.5V$	 - -	- - -	500 200 100 50	ns/V

NOTE:

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
± I _{IK}	DC input diode current	$V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5V$	20	mA
± I _{OK}	DC output diode current	$V_{O} < -0.5 \text{ or } V_{O} > V_{CC} + 0.5V$	50	mA
±I _O	DC output source or sink current – bus driver outputs	$-0.5V < V_O < V_{CC} + 0.5V$	35	mA
± I _{GND} , ± I _{CC}	DC V _{CC} or GND current for types with – bus driver outputs		70	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

^{1.} The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.

^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +8	5°C	-40°C to	+125°C	UNIT
			MIN	TYP ¹	MAX	MIN	MAX	
		V _{CC} = 1.2V	0.9			0.9		
V_{IH}	HIGH level Input	V _{CC} = 2.0V	1.4			1.4		V
VIН	voltage	V _{CC} = 2.7 to 3.6V	2.0			2.0]
		$V_{CC} = 4.5 \text{ to } 5.5 \text{V}$	0.7 * V _{CC}			0.7 * V _{CC}		
		V _{CC} = 1.2V			0.3		0.3	
V_{IL}	LOW level Input	$V_{CC} = 2.0V$			0.6		0.6	\ _\
۷IL	voltage	$V_{CC} = 2.7 \text{ to } 3.6 \text{V}$			0.8		0.8]
		$V_{CC} = 4.5 \text{ to } 5.5$			0.3 * V _{CC}		0.3 * V _{CC}	
		$V_{CC} = 1.2V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$		1.2				
	LUCIUS STATE	$V_{CC} = 2.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	1.8	2.0		1.8		
V_{OH}	HIGH level output voltage; all outputs	$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	2.5	2.7		2.5		V
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	2.8	3.0		2.8		
		$V_{CC} = 4.5V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	4.3	4.5		4.3		
V _{OH}	HIGH level output voltage; BUS driver	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 8\text{mA}$	2.40	2.82		2.20		V
VOH	outputs	$V_{CC} = 4.5V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 16mA$	3.60	4.20		3.50		`
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0				
		$V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2	
V_{OL}	LOW level output voltage; all outputs	$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2	V
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2	
		$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2	
V _{OL}	LOW level output voltage; BUS driver	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 8mA$		0.20	0.40		0.50	V
VOL	outputs	$V_{CC} = 4.5V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 16$ mA		0.35	0.55		0.65	ľ
I _I	Input leakage current	$V_{CC} = 5.5V$; $V_I = V_{CC}$ or GND			1.0		1.0	μА
I _{OZ}	3-State output OFF-state current	V_{CC} = 5.5V; V_I = V_{IH} or V_{IL} ; V_O = V_{CC} or GND			5		10	μА
I _{CC}	Quiescent supply current; MSI	$V_{CC} = 5.5V$; $V_I = V_{CC}$ or GND; $I_O = 0$			20.0		160	μА
Δl _{CC}	Additional quiescent supply current per input	cent supply $V_{CC} = 2.7V \text{ to } 3.6V; V_I = V_{CC} - 0.6V$			500		850	μΑ

NOTE:

^{1.} All typical values are measured at $T_{amb} = 25$ °C.

Octal buffer/line driver; inverting (3-State)

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AC CHARACTERISTICS

GND = 0V; $t_r = t_f \le 2.5 ns$; $C_L = 50 pF$; $R_L = 1 K\Omega$

			CONDITION			LIMITS			
SYMBOL	PARAMETER	WAVEFORM	CONDITION	_	40 to +85 °	C	-40 to	+125 °C	UNIT
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX	
			1.2		55				
	Propagation delay		2.0		19	24		31	
t _{PHL} /t _{PLH}	1A _n to 1Y _n ;	Figures 1	2.7		14	18		23	ns
	2A _n to 2Y _n		3.0 to 3.6		10 ²	14		18	
			4.5 to 5.5			12		15	
			1.2		70				
	3-State output enable time 10E to 1Yn;	Figures 2	2.0		24	32		41	
t _{PZH} /t _{PZL}			2.7		18	24		30	ns
	2 OE to 2Y _n		3.0 to 3.6		13 ²	19		24	
			4.5 to 5.5			16		20	
			1.2		65				
	3-State output disable time		2.0) 24 29		29		36	
t _{PHZ} /t _{PLZ}	1 OE to 1Y _n ;	Figures 2	2.7		18	22		27	ns
	2 OE to 2Y _n		3.0 to 3.6		14 ²	18		22	
			4.5 to 5.5			15		18	

NOTES:

- 1. Unless otherwise stated, all typical values are measured at T_{amb} = 25°C
- 2. Typical values are measured at $V_{CC} = 3.3 \text{ V}$.

AC WAVEFORMS

 V_M = 1.5V at $V_{CC} \ge$ 2.7V and \le 3.6V;

 $V_{\mbox{\scriptsize M}}$ = 0.5V \times $V_{\mbox{\scriptsize CC}}$ at $V_{\mbox{\scriptsize CC}}$ < 2.7V and \geq 4.5V.

 $\mbox{V}_{\mbox{OL}}$ and $\mbox{V}_{\mbox{OH}}$ are the typical output voltage drop that occur with the output load.

 $V_X = V_{OL} + 0.3V$ at $V_{CC} \ge 2.7V$ and $\le 3.6V$

 $V_X = V_{OL} + 0.1V \times V_{CC}$ at $V_{CC} < 2.7V$ and 4.5V

 $V_Y = V_{OH} - 0.3V$ at $V_{CC} \ge 2.7V$ and $\le 3.6V$

 $V_Y = V_{OH} - 0.1 \times V_{CC}$ at $V_{CC} < 2.7V$ and $\geq 4.5V$

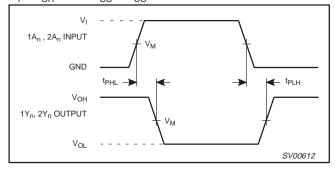


Figure 1. Input $(1A_n, 2A_n)$ to output $(1Y_n, 2Y_n)$ propagation delays.

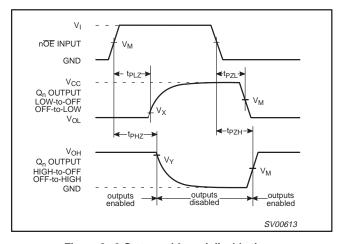


Figure 2. 3-State enable and disable times.

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TEST CIRCUIT

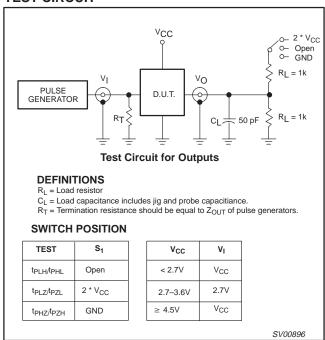


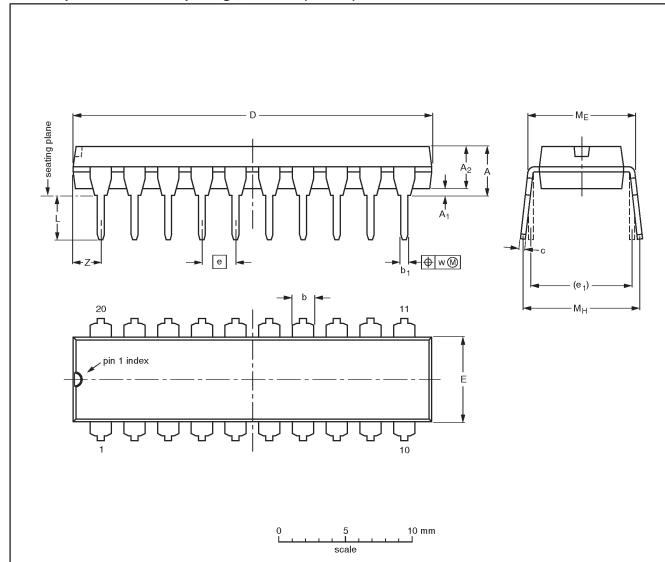
Figure 3. Load circuitry for switching times.

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DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

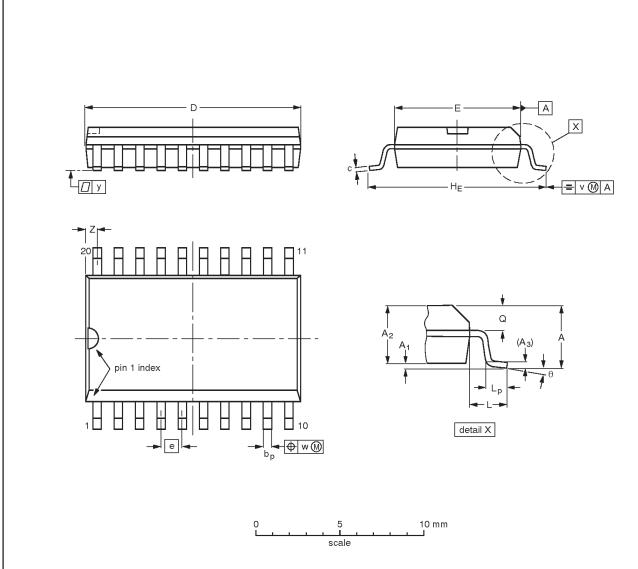
OUTLINE		REFERENCES EUROPEAN					
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT146-1			SC603			92-11-17 95-05-24	

Octal buffer/line driver; inverting (3-State)

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SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bp	O	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	٧	w	у	z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016		0.01	0.01	0.004	0.035 0.016	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

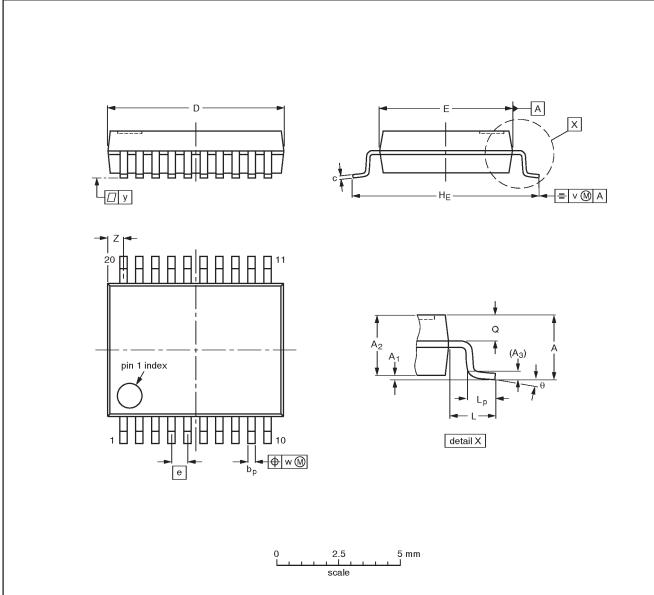
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT163-1	075E04	MS-013AC			-92-11-17 95-01-24	

Octal buffer/line driver; inverting (3-State)

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bр	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

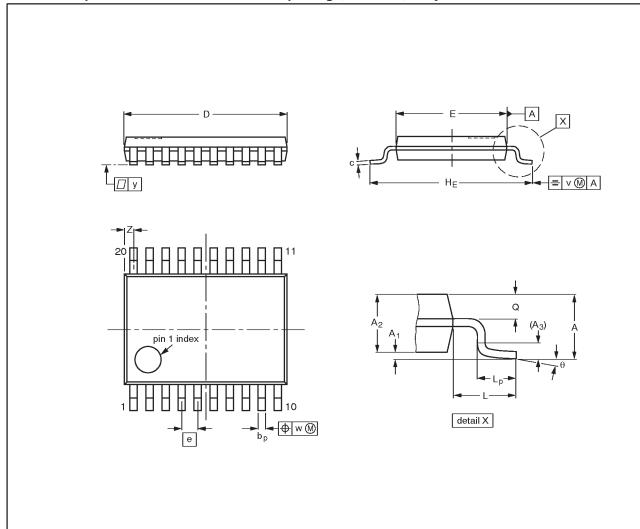
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT339-1		MO-150AE				93-09-08 95-02-04

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



0 2.5 5 mm scale

DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	рb	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1550E DATE
SOT360-1		MO-153AC				-93-06-16- 95-02-04

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DEFINITIONS						
Data Sheet Identification	Product Status	Definition				
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